

SiGe:C low-noise amplifier MMIC for GPS, GLONASS, Galileo and COMPASS and LTE B32 Rev. 7.3 — 16 May 2019 Product data shee

Product data sheet

General description 1

The BGU8009 is, also known as the GPS1201M, a Low-Noise Amplifier (LNA) for GNSS receiver and LTE Band 32 down link applications. This BGU8009 is available in a small plastic 6-pin extremely thin leadless package. The BGU8009 requires one external matching inductor and one external decoupling capacitor.

The BGU8009 adapts itself to the changing environment resulting from co-habitation of different radio systems in modern cellular handsets. It has been designed for low power consumption and optimal performance when jamming signals from co-existing cellular transmitters are present. At low jamming power levels, it delivers 18 dB gain at a noise figure of 0.65 dB. During high jamming power levels, resulting, for example from a cellular transmit burst, it temporarily increases its bias current to improve sensitivity.

2 Features and benefits

- Covers full GNSS L1 band, from 1559 MHz to 1610 MHz and LTE band 32 from 1452 MHz to 1496 MHz
- Optionally also the GNSS lower L-band can be covered (from 1164 MHz to 1299) MHz) by adding additional matching components as described in the application note AN11353.
- GNSS:
 - Noise figure = 0.65 dB
 - Gain 18 dB
 - High input 1 dB compression point of -7 dBm
 - High out of band IP3_i of 6 dBm
- LTE B32:
 - Noise figure = 0.65 dB
 - Gain 20 dB
 - High input 1 dB compression point of -8.5 dBm
- Supply voltage 1.5 V to 3.1 V
- Optimized performance at low supply current of 4.2 mA
- Power-down mode current consumption < 1 μA
- Integrated temperature stabilized bias for easy design.
- · Requires only one input matching inductor and one supply decoupling capacitor
- Input and output DC decoupled
- ESD protection on all pins (HBM > 2 kV)
- Integrated matching for the output
- Available in a 6-pins leadless package 1.1 mm x 0.9 mm x 0.47 mm; 0.4 mm pitch: SOT1230
- 180 GHz transit frequency SiGe:C technology
- Moisture sensitivity level 1



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3 Applications

- Smart phones
- Feature phones
- Tablets
- Digital still cameras
- Digital video cameras
- RF front-end modules
- Complete GNSS modules
- Personal health applications

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Quick reference data 4

Table 1. Quick reference data GNSS band L1

f = 1575 MHz; V_{CC} = 2.85 V; P_i < -40 dBm; T_{amb} = 25 °C; input matched to 50 Ω using a 5.6 nH inductor, see Figure 34, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CC}	supply voltage			1.5	-	3.1	V
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V					
		• P _i < -40 dBm		2.6	4.4	6.5	mA
		• P _i = -20 dBm		-	9	-	mA
G _p	power gain	P _i < -40 dBm		16	17.8	20	dB
		P _i = -20 dBm		-	20.0	-	dB
NF	noise figure	P _i < -40 dBm	[1]	-	0.65	1.2	dB
		P _i < -40 dBm	[1]	-	0.70	1.25	dB
P _{i(1dB)}	input power at 1 dB gain	V _{CC} = 1.8 V		-	-10	-	dBm
	compression	V _{CC} = 2.85 V		-12.5	-7	-	dBm
IP3 _i	input third-order intercept point	V _{CC} = 1.8 V	[2]	-	3	-	dBm
		V _{CC} = 2.85 V	[2]	-	6	-	dBm

[1] PCB losses are subtracted.

[2] f₁ = 1713 MHz; f₂ = 1851 MHz; P_i = -20 dBm per carrier

Table 2. Quick reference data LTE B32

f = 1474 MHz; V_{CC} = 2.8 V; P_i = -30 dBm; T_{amb} = 25 °C; input matched to 50 Ω using a 9.1 nH inductor, see Figure 34, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.5	-	3.1	V
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V	-	4.4	-	mA
G _p	power gain			20		dB
NF	noise figure	[1]	-	0.65	-	dB
P _{i(1dB)}	input power at 1 dB gain compression	V _{CC} = 1.8 V	-	-11	-	dBm
		V _{CC} = 2.8 V	-	-8.5	-	dBm
IP3 _i	input third-order intercept point	V _{CC} = 1.8 V ^[2]	-	-7	-	dBm
		V _{CC} = 2.8 V ^[2]	-	-6	-	dBm

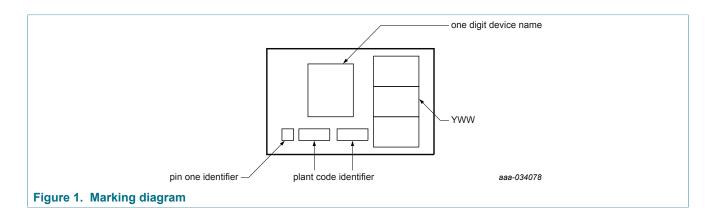
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5 Ordering information

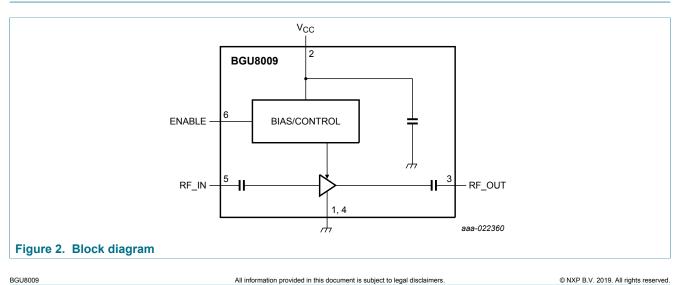
Table 3. Orderin	ng information							
Type number	Package							
	Name	Description	Version					
BGU8009	XSON6	plastic very thin small outline package; no leads; 6 terminals; body $1.1 \times 0.9 \times 0.47$ mm	SOT1230					
OM7820	EVB	BGU8009 evaluation board, MMIC only	-					
OM7824	EVB	BGU8009 evaluation board, front-end EVB	-					
OM17066	EVB	BGU8009 evaluation board for LTE B32						

6 Marking

Table 4. Marking code				
Type number	Marking code	Date code		
BGU8009	A	YWW		



7 Block diagram

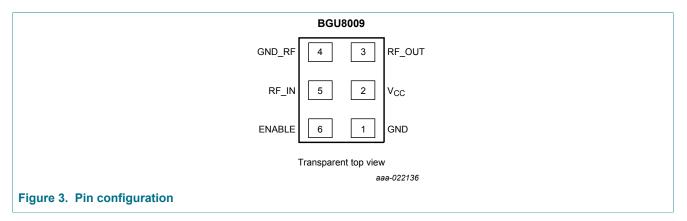


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8 **Pinning information**

8.1 Pinning



8.2 Pin description

Table 5. Pin description

Symbol	Pin	Description
GND	1	ground
V _{CC}	2	supply voltage
RF_OUT	3	RF output
GND_RF	4	RF ground
RF_IN	5	RF input
ENABLE	6	enable

9 Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Absolute Maximum Ratings are given as Limiting Values of stress conditions during operation, that must not be exceeded under the worst probable conditions.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage	[1]	-0.5	+5.0	V
V _{I(ENABLE)}	input voltage on pin ENABLE	$V_{I(ENABLE)} < V_{CC} + 0.6 V$ [1] [2]		+5.0	V
V _{I(RF_IN)}	input voltage on pin RF_IN	DC, $V_{I(RF_{IN})} < V_{CC} + 0.6 V$ [1] [2] [3]		+5.0	V
V _{I(RF_OUT)}	input voltage on pin RF_OUT	DC, $V_{I(RF_{OUT})} < V_{CC} + 0.6 V$ [1] [2] [3]	-0.5	+5.0	V
Pi	input power	1575 MHz ^[1]	-	10	dBm
		1474 MHz [1]	-	10	dBm
P _{tot}	total power dissipation	T _{sp} ≤ 130 °C	-	55	mW

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Symbol	Parameter	Conditions	Min	Max	Unit
T _{stg}	storage temperature		-65	+150	°C
Т _ј	junction temperature		-	150	°C
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM) according to JEDEC standard JS-001-2010	-	±2	kV
		Charged Device Model (CDM) according to JEDEC standard JESD22-C101C	-	±1	kV

[1]

Stressed with pulses of 200 ms in duration, with application circuit as in Figure 34. Warning: due to internal ESD diode protection, the applied DC voltage shall not exceed V_{CC} + 0.6 V and shall not exceed 5.0 V to avoid excess current. The RF input and RF output are AC coupled through internal DC blocking capacitors. [2] [3]

10 Recommended operating conditions

Table 7. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{CC}	supply voltage		1.5	-	3.1	V
T _{amb}	ambient temperature		-40	+25	+85	°C
V _{I(ENABLE)}	input voltage on pin ENABLE	OFF state	-	-	0.3	V
		ON state	0.8	-	-	V

11 Thermal characteristics

Table 8. T	hermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point		225	K/W

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12 Characteristics GNSS band L1

Table 9. Characteristics at V_{CC} = 1.8 V

 $f = 1575 \text{ MHz}; V_{CC} = 1.8 \text{ V}; V_{I(ENABLE)} >= 0.8 \text{ V}; P_i < -40 \text{ dBm}; T_{amb} = 25 \text{ °C}; input matched to 50 \Omega using a 5.6 nH inductor, and the second second$ see Figure 34, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V		-	-	-	-
		P _i < -40 dBm		2.3	4.2	6.2	mA
		P _i = -20 dBm		-	9	-	mA
		V _{I(ENABLE)} ≤ 0.3 V		-	-	1	μA
G _p	power gain	no jammer		16	17.6	20	dB
		P _{jam} = -20 dBm; f _{jam} = 850 MHz		-	19.8	-	dB
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz		-	20.0	-	dB
RL _{in}	input return loss	P _i < -40 dBm		-	9	-	dB
		P _i = -20 dBm		-	11	-	dB
RL _{out}	output return loss	P _i < -40 dBm		-	15	-	dB
		P _i = -20 dBm		-	15	-	dB
ISL	isolation			-	37	-	dB
NF	noise figure	P _i = -40 dBm; no jammer	[1]	-	0.65	1.2	dB
		P _i = -40 dBm; no jammer	[2] [1]	-	0.70	1.25	dB
		P _{jam} = -20 dBm; f _{jam} = 850 MHz	[2]	-	0.9	-	dB
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz	[2]	-	1.2	-	dB
P _{i(1dB)}	input power at 1 dB gain compression		[1]	-	-10	-	dBm
IP3 _i	input third-order intercept point		[1] [3]	-	3	-	dBm
			[1] [4]	-	3	-	dBm
t _{on}	turn-on time	time from $V_{I(\text{ENABLE})}$ ON to 90 % of the gain		-	-	2	μs
t _{off}	turn-off time	time from $V_{I(\text{ENABLE})}$ OFF to 10 % of the gain		-	-	1	μs

Guaranteed by device design; not tested in production. [1]

[2] [3] Including PCB losses.

 $f_1 = 1713$ MHz; $f_2 = 1851$ MHz, $P_i = -20$ dBm per carrier. $f_1 = 1713$ MHz; $f_2 = 1851$ MHz, $P_{i(1)} = -20$ dBm, $P_{i(2)} = -65$ dBm. [4]

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Table 10. Characteristics at Vcc = 2.85 V

f = 1575 MHz; V_{CC} = 2.85 V; $V_{I(ENABLE)}$ >= 0.8 V; P_i < -40 dBm; T_{amb} = 25 °C; input matched to 50 Ω using a 5.6 nH inductor, see Figure 34, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V		-	-	-	-
		• P _i < -40 dBm		2.6	4.4	6.5	mA
		• P _i = -20 dBm		-	9	-	mA
		V _{I(ENABLE)} ≤ 0.3 V		-	-	1	μA
G _p	power gain	no jammer		16	17.8	20	dB
		• P _{jam} = -20 dBm; f _{jam} = 850 MHz		-	20.0	-	dB
		• P _{jam} = -20 dBm; f _{jam} = 1850 MHz		-	20.2	-	dB
RL _{in}	input return loss	P _i < -40 dBm		-	9	-	dB
		P _i = -20 dBm		-	11	-	dB
RL _{out}	output return loss	P _i < -40 dBm		-	15	-	dB
		P _i = -20 dBm		-	15	-	dB
ISL	isolation			-	37	-	dB
NF	noise figure	P _i = -40 dBm; no jammer	[1]	-	0.65	1.2	dB
		P _i = -40 dBm; no jammer	[2] [1]	-	0.70	1.25	dB
		P _{jam} = -20 dBm; f _{jam} = 850 MHz	[2]	-	0.9	-	dB
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz	[2]	-	1.2	-	dB
P _{i(1dB)}	input power at 1 dB gain compression		[1]	-12 .5	-7	-	dBm
IP3 _i	input third-order intercept point		[1] [3]	0	6	-	dBm
			[1] [4]	0	6	-	dBm
t _{on}	turn-on time	time from $V_{I(\text{ENABLE})}$ ON to 90 % of the gain		-	-	2	μs
t _{off}	turn-off time	time from $V_{I(\text{ENABLE})}\text{OFF}$ to 10 % of the gain		-	-	1	μs

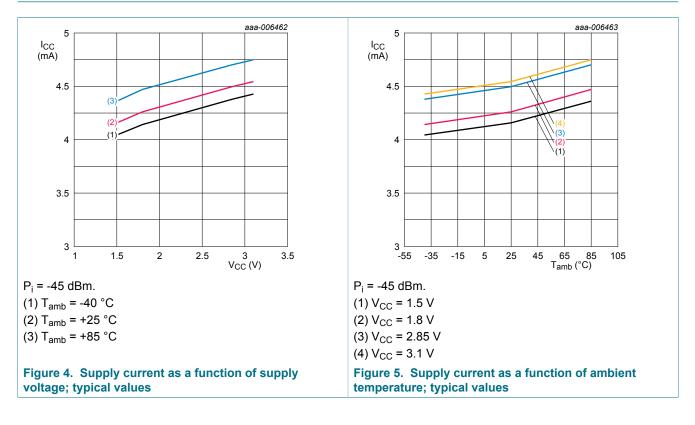
[1] Guaranteed by device design; not tested in production.

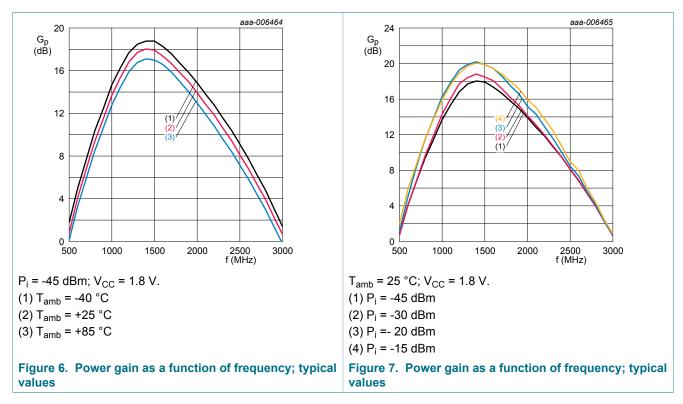
[2] [3]

Including PCB losses. $f_1 = 1713 \text{ MHz}$; $f_2 = 1851 \text{ MHz}$, $P_i = -20 \text{ dBm per carrier}$. $f_1 = 1713 \text{ MHz}$; $f_2 = 1851 \text{ MHz}$, $P_{i(1)} = -20 \text{ dBm}$, $P_{i(2)} = -65 \text{ dBm}$. [4]

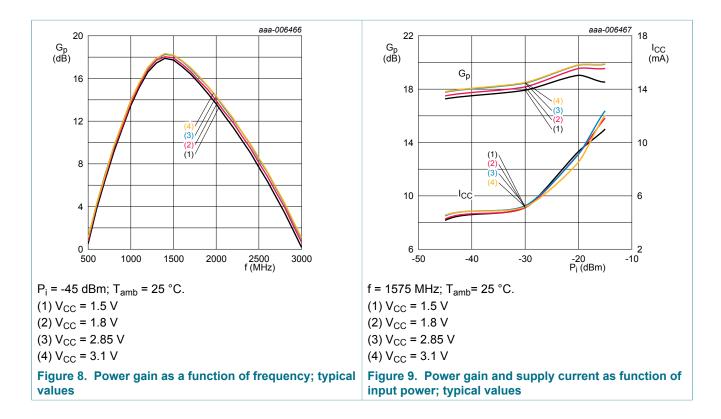
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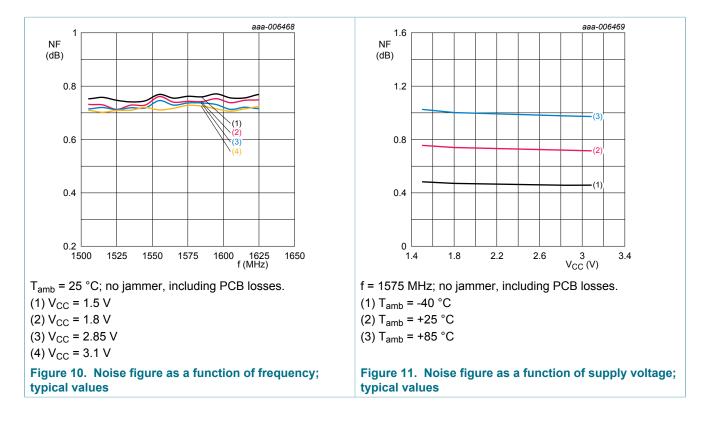
13 Graphs GNSS band L1



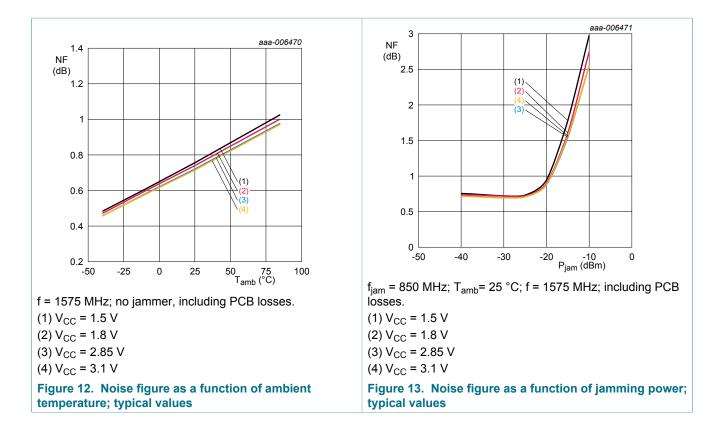


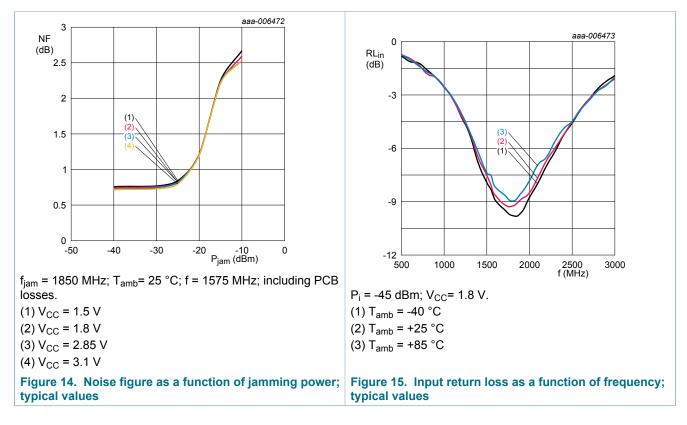
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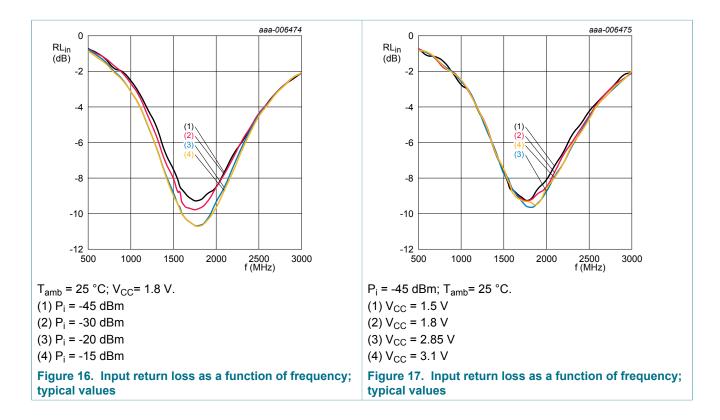


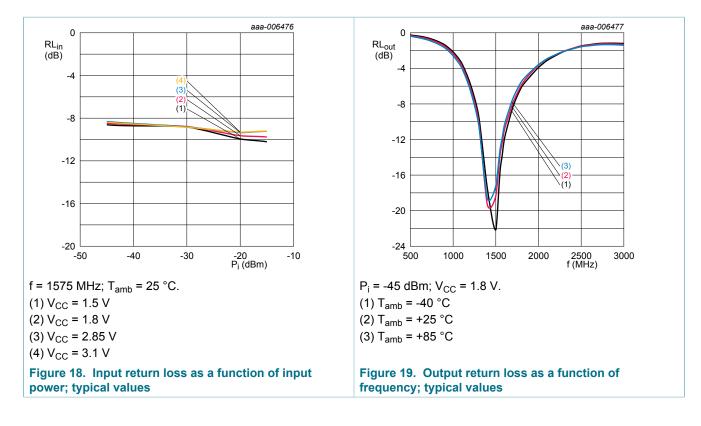
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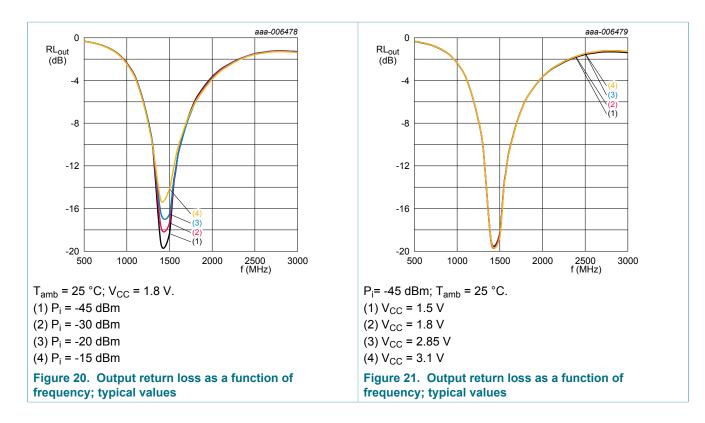


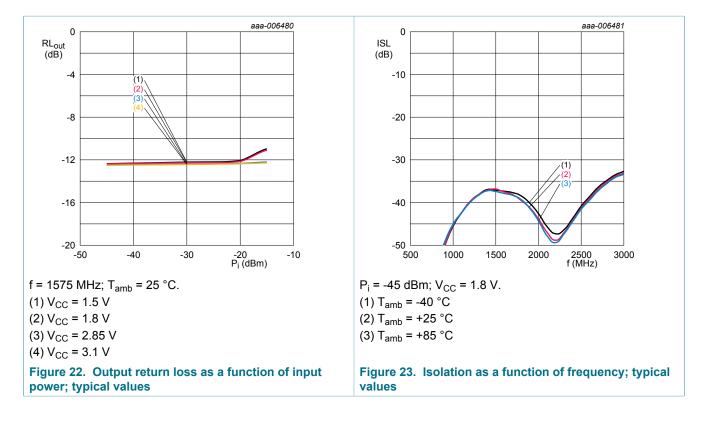
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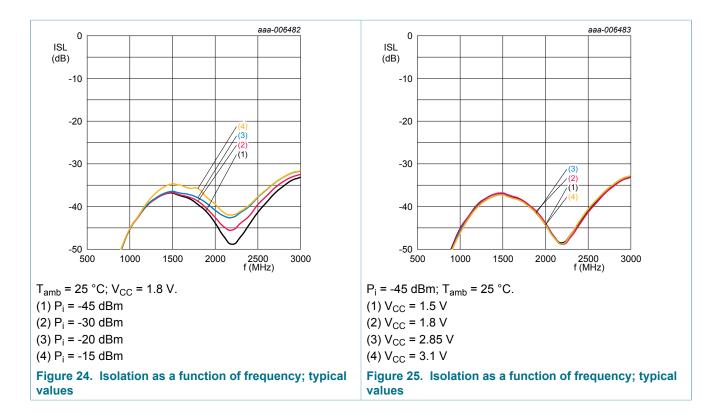
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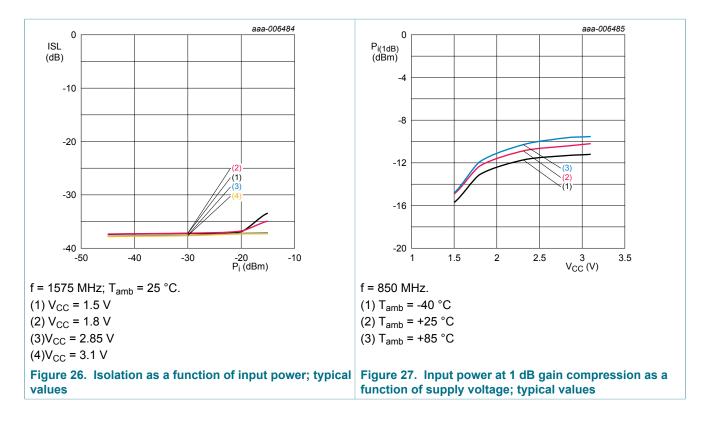




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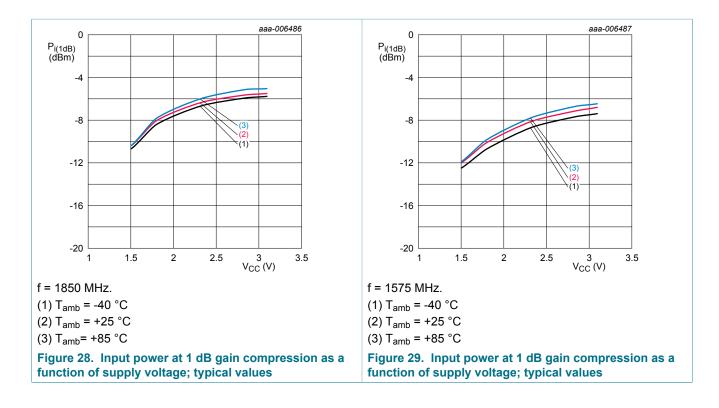
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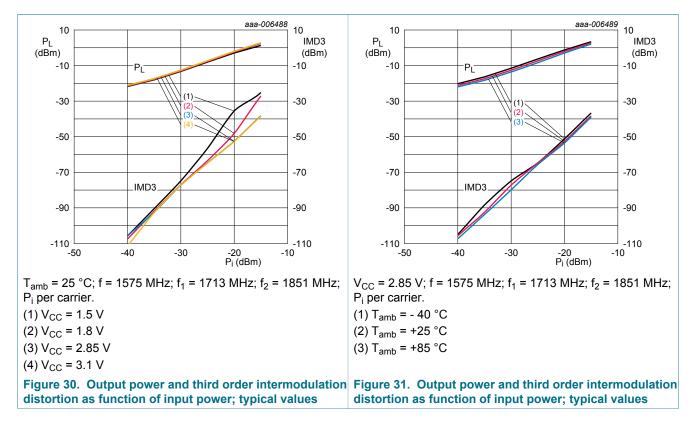




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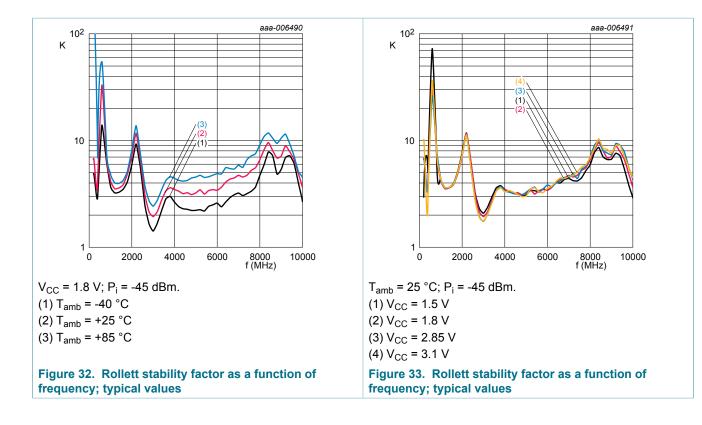
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14 Characteristics LTE B32

Table 11. Characteristics

1474 MHz; V_{CC} = 1.8 V; P_i = -30 dBm; T_{amb} = 25 °C; input matched 50 Ω using application diagram from Figure 34 and component values as in Table 14. Unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Gain Mo	de	·					J
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V		-	4.4	-	mA
G _p	power gain			-	20	-	dB
RL _{in}	input return loss			-	17.5	-	dB
RL _{out}	output return loss			-	23.5	-	dB
ISL	isolation			-	36	-	dB
NF	noise figure		[1] [2]	-	0.65	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression		[2]	-	-11	-	dBm
IP3 _i	input third-order intercept point	Δf = 1 MHz, P _i = -30 dBm	[2] [3]	-	-7	-	dBm
t _{on}	turn-on time	Time from $V_{I(\text{CTRL})}\text{ON}$ to 90 % of the gain		-	-	2	μs
t _{off}	turn-off time	Time from $V_{I(CTRL)}OFF$ to 10 % of the gain		-	-	1	μs
К	Rollett stability factor			1	-	-	-

PCB losses are subtracted. [1]

[2] [3] Guaranteed by device design; not tested in production.

f₁= 1474 MHz, f₂ = 1475 MHz

Table 12. Characteristics

1474 MHz; V_{CC} =2.8 V; P_i = -30 dBm; T_{amb} = 25 °C; input matched 50 Ω using application diagram from Figure 34 and component values as in Table 14. Unless otherwise specified.

Symbol	Parameter	Conditions	Μ	in Typ	Max	Unit
Gain Mode						
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V	-	4.6		mA
G _p	power gain		-	20	-	dB
RL _{in}	input return loss		-	17.5	-	dB
RL _{out}	output return loss		-	23.5	-	dB
ISL	isolation		-	36	-	dB
NF	noise figure	[1]	[2] _	0.65	-	dB
P _{i(1dB)}	input power at 1 dB gain compression		[2] _	-8.5	-	dBm
IP3 _i	input third-order intercept point	$\Delta f = 1 \text{ MHz}, P_i = -30 \text{ dBm}$ [2]	[3] -	-6		dBm
t _{on}	turn-on time	Time from $V_{I(CTRL)}ON$ to 90 % of the gain	-	-	2	μs
t _{off}	turn-off time	Time from $V_{I(CTRL)}OFF$ to 10 % of the gain	-	-	1	μs
к	Rollett stability factor		1	-	-	-

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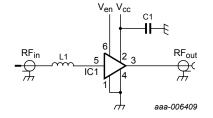
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[1] PCB losses are subtracted.

- [2] [3] Guaranteed by device design; not tested in production.
- f₁= 1474 MHz, f₂ = 1475 MHz

15 Application information

15.1 GNSS and LTE B32 LNA



For a list of components, see Table 13 (GNSS) and Table 14 (LTE B32). Figure 34. Schematics GNSS LNA and LTE B32 evaluation board

Table 13. List of components for GNSS applications See Figure 34 for schematics.

Component	Description	Value	Remarks		
EVB	Evaluation Board	SOT1230 - EVB	EVB for GNSS application, NXP Semiconductors		
C1	decoupling capacitor	1 nF			
IC1	BGU8009	-	NXP Semiconductors		
L1	high-quality matching inductor	5.6 nH	GNSS band L1: 1559 < f < 1610 MHz Murata LQW15A		

SiGe:C low-noise amplifier MMIC for GPS, GLONASS, Galileo and COMPASS and LTE B32

Table 14. List of components for LTE B32 applications

See Figure 34 for schematics.

Component	Description	Value	Remarks
EVB	Evaluation Board	OM17025 (SOT1230, SOT1232)	EVB for LTE application, NXP Semiconductors
C1	decoupling capacitor	1 nF	
IC1	BGU8009	-	NXP Semiconductors
L1	high-quality matching inductor	9.1 nH	LTE band 32 L1: 1452 < f < 1496 MHz Murata LQW15A

GNSS: See application note AN11288 for details. LTE B32: See application note AN11986.

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16 Package outline

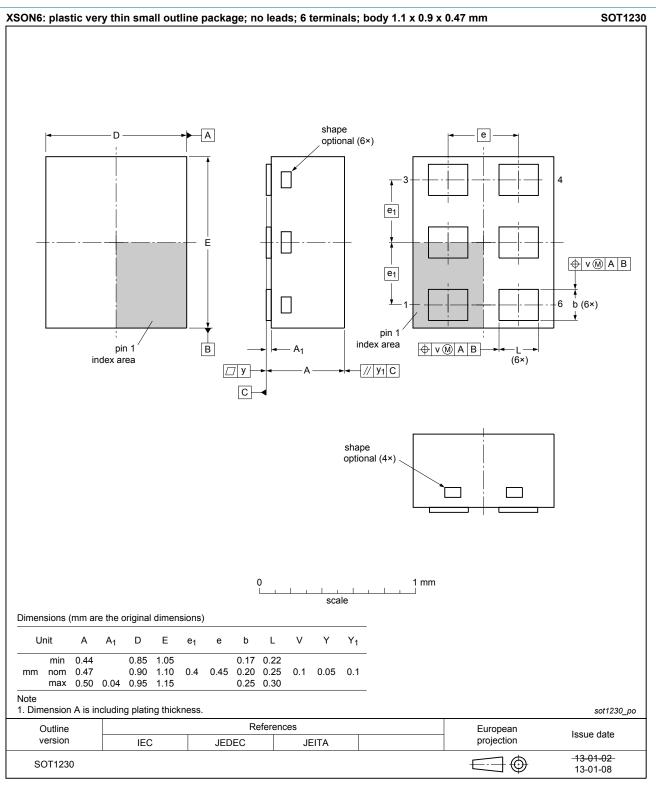


Figure 35. Package outline SOT1230 (XSON6)

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17 Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the *ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A* or equivalent standards.

18 Abbreviations

Table 15. Abbreviations				
Acronym	Description			
GLONASS	global navigation satellite system			
GNSS	global navigation satellite system			
GPS	global positioning system			
НВМ	human body model			
MMIC	monolithic microwave-integrated circuit			
РСВ	printed-circuit board			
SiGe:C	silicon germanium carbon			

19 Revision history

Table 16. Revision history

Table To. Revisio			i	i		
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BGU8009 v.7.3	20190516	Product data sheet	-	BGU8009 v.7.2		
Modifications:	added general Marking diagram					
BGU8009 v.7.2	20190510	Product data sheet	-	BGU8009 v.7.1		
Modifications:	removed incorrect marking code descriptionadapted date code notation to the Marking code table					
BGU8009 v.7.1	20180416	Product data sheet	-	BGU8009 v.7		
Modifications:	adapted the data sheet to the new look and feel					
BGU8009 v.7	20170720	Product data sheet	-	BGU8009 v.6		
Modifications:	 <u>Section 1 "General description" on page 1</u>: added GPS1201M according to our new naming convention <u>Section 2 "Features and benefits" on page 1</u>: added LTE B32 characteristics <u>Section 14 "Characteristics LTE B32" on page 17</u> added <u>Table 13</u> added EVB 					
BGU8009 v.6	20170118	Product data sheet	-	BGU8009 v.5		
Modifications:	<u>Section 1</u> : added GPS1201M according to our new naming convention					
BGU8009 v.5	20160405	Product data sheet	-	BGU8009 v.4		
Modifications:	updated Figure 2					
BGU8009 v.4	20160316	Product data sheet	-	BGU8009 v.3		

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Document ID	Release date	Data sheet status	Change notice	Supersedes		
Modifications:	updated <u>Table 8</u> and <u>Table 9 on page 6</u>					
BGU8009 v.3	20141001	Product data sheet	-	BGU8009 v.2		
Modifications:	Section 6.1 on page 3: Section has been added.					
BGU8009 v.2	20130619	Product data sheet	-	BGU8009 v.1		
BGU8009 v.1	20130201	Product data sheet	-	-		

SiGe:C low-noise amplifier MMIC for GPS, GLONASS, Galileo and COMPASS and LTE B32

20 Legal information

20.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

Please consult the most recently issued document before initiating or completing a design. [1]

[2] [3] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 16 May 2019 Document identifier: BGU8009 Document number:

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